



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

N RE APPLICATION OF

Michel A. Rosa and Decai Sun

FOR

MICRO-DEVICE ASSEMBLY WITH

ELECTRICAL CAPABILITIES

SERIAL NO.

09/725,836

FILED

November 29, 2000

EXAMINER

LEE, Jinhee J.

ART UNIT

2831

LAST OFFICE ACTION

June 24, 2003

ATTORNEY DOCKET NO.

D/A0597

XER 2 0368

SECOND SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner of Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In accordance with 37 C.F.R. §§ 1.56, 1.97, 1.98 and MPEP § 609, applicant(s) submit(s) the following Second Supplemental Disclosure Statement concerning art of which the applicant(s) is(are) aware. A copy of PTO-1449 is enclosed herewith.

This Information Disclosure Statement is not intended to constitute an admission that any patent, publication or other information referred to herein or submitted herewith is "prior art" for this invention unless specifically designated as such.

In accordance with 37 C.F.R. §1.97(g) and (h), the filing of this Information Disclosure Statement shall not be construed to mean that a search has been made or that no other material information as defined in 37 C.F.R. §1.56(b) exists.

Under § 1.98(a)(3), no concise explanation of relevance is required for information that is in the English language. Accordingly, the enclosed patents require no further

Atty. Dkt. No. D/A0597 XERZ 2 00368 July 24, 2003 Page 2

explanation (or no translation is available).

Under § 1.97(e)(2), the undersigned certifies that items of information --- Motamedi et al., U.S. Patent No. 5,903,380 --- contained in the Information Disclosure Statement was not cited in a communication from a foreign patent office in a counterpart foreign application, and to the knowledge of the person signing the certification after making reasonable inquiry, no item of information contained in the Information Disclosure Statement was known to any individual designated in Section 1.56(c) more than three (3) months prior to the filing of the Information Disclosure Statement.

Particularly, this information was cited in U.S. Patent Application Serial No. 09/724,329, which was cited to the Examiner in this application by the Letter of October 1, 2001. In the alternative, this submission is being made before the entry of a final Office Action.

Should it be determined a fee is required, applicants authorize and request the fee be charged to Deposit Account No. 24-0037.

Respectfully submitted,

FAY, SHARPE, FAGAN, MINNICH & McKEE, LLP

Mark S. Svat Reg. No. 34,261

1100 Superior Avenue

Seventh Floor

Cleveland, Ohio 44114-2518

(216) 861-5582

CERTIFICATE OF MAILING

I hereby certify that this SECOND SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on July 24, 2003.

Karen M Foreyth

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APPLICANT'S(S') 2nd Supplemental INFORMATION DISCLOSURE STATEMENT			Applicant(s	Applicant(s): Decai Sun, et al.				
			Filing Date: November 29, 2000		Grou	Group: 2831		
U.S. PATENT DOCUMENTS								
Initial*		Document No.	Date	Name	Class	Subcl.	Filing Date	
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if in conformance and not considered. Include copy of this form with next communication to applicant.